

DOCKET NO: 288839US0PCT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :  
EKKEHARD MUEH, ET AL. : EXAMINER: J.A. MILLER, JR.  
SERIAL NO: 10/586,675 :  
FILED: JULY 20, 2006 : GROUP ART UNIT: 1715  
FOR: SILICON COMPOUNDS FOR PRODUCING SIO<sub>2</sub>-CONTAINING INSULATING  
LAYERS ON CHIPS

AMENDMENT AND REQUEST FOR RECONSIDERATION

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

Responsive to the Office Action dated March 14, 2011, Applicants respectfully request reconsideration of the above-identified application in view of the following amendments and remarks:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

A discussion of the **Support for the Amendments** begins on page 5 of this paper.

**Remarks** begin on page 6 of this paper.